ISSI®

16-CHANNEL COLOR LED DRIVER

June 2018

GENERAL DESCRIPTION

The IS31FL3726 is comprised of constant-current drivers designed for color LEDs. The output current value can be set using an external resistor. The output current value can be adjusted from 5mA to 60mA through the external resistor.

As a result, all outputs will have virtually the same current levels.

This driver incorporates 16-channel constant current outputs, a 16-bit shift register, a 16-bit latch and a 16-bit AND-gate circuit.

These drivers have been designed using the CMOS process.

APPLICATIONAS

- Cellular phones
- MP3/MP4/CD/minidiskplayers
- Toys

FEATURES

- Output current capability and number of outputs: 60mA × 16 outputs
- Constant current range: 5mA to 60mA
- Application output voltage: ≥0.4V
- For anode-common LEDs
- Power supply voltage range, V_{DD} = 3.3V to 5.5V
- Serial and parallel data transfer rate: 20MHz (Max. cascade connection)
- Operating temperature range, T_A= -40°C ~ +85°C
- Package: QFN-24 (4mm×4mm) and eTSSOP-24
- Current accuracy (All output on)

Output	Current /	Output		
voltage	Between Bits	Between ICs	Current	
≥0.4V	±4%	±20%	5mA ~ 60mA	

TYPICAL APPLICATION CIRCUIT

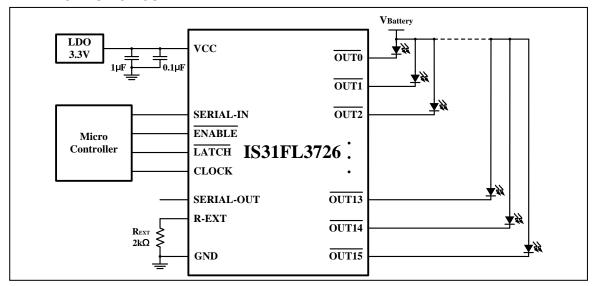


Figure 1 Typical Application Circuit



TYPICAL APPLICATION CIRCUIT (CONTINUE)

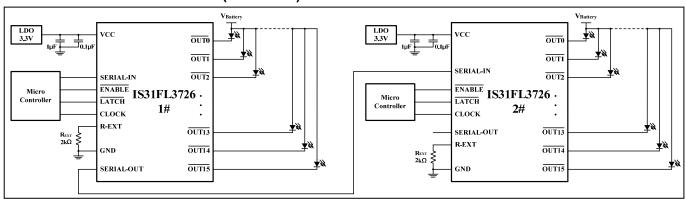
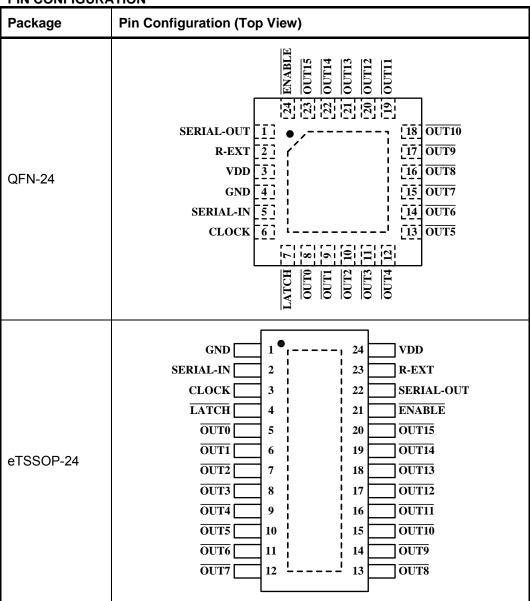


Figure 2 Typical Application Circuit (Synchronization-Work)



PIN CONFIGURATION





PIN DESCRIPTION

No.		5.	5
QFN	eTSSOP	Pin	Description
1	22	SERIAL-OUT	Output terminal for serial data input on SERIAL-IN terminal.
2	23	R-EXT	Input terminal used to connect an external resistor. This regulated the output current.
3	24	VDD	Supply voltage terminal.
4	1	GND	GND terminal for control logic.
5	2	SERIAL-IN	Input terminal for serial data for data shift register.
6	3	CLOCK	Input terminal for clock for data shift on rising edge.
7	4	LATCH	Input terminal for data strobe When the LATCH input is driven High, data is not latched. When it is pulled Low, data is latched.
8 ~ 23	5~20	OUT0~OUT15	Constant-current output terminals.
24	21	ENABLE	Input terminal for output enable. All outputs (OUT0 to OUT15) are turned off, when the ENABLE terminal is driven High .And are
		turned on, when the terminal is driven Low.	
		Thermal Pad	Connect to GND.





ORDERING INFORMATION Industrial Range: -40°C to +85°C

Order Part No.	Package	QTY
IS31FL3726-QFLS2-TR	QFN-24, Lead-free	2500/Reel
IS31FL3726-ZLS2-TR IS31FL3726-ZLS2	eTSSOP-24, Lead-free	2500/Reel 62/Tube

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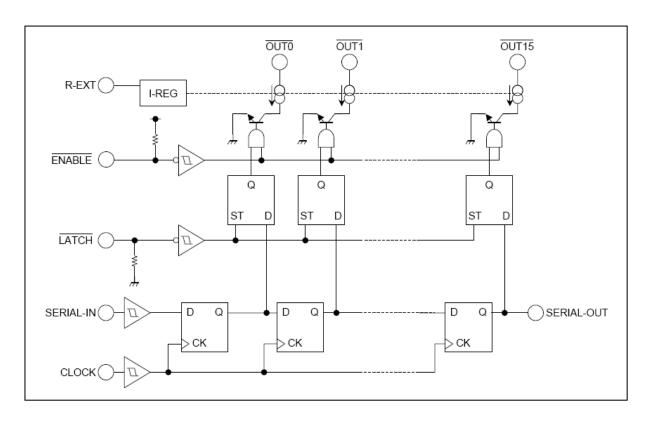
a.) the risk of injury or damage has been minimized;

b.) the user assume all such risks; and

c.) potential liability of Integrated Silicon Solution, Inc is adequately protected under the circumstances



FUNCTIONAL BLOCK DIAGRAM





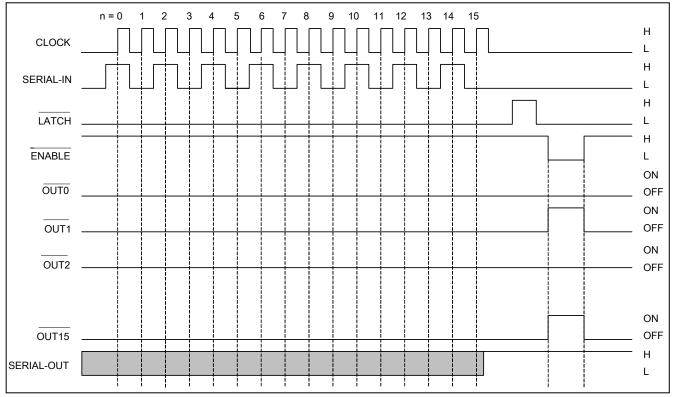


Figure 3 Timing Diagram

Warning: Latch circuit is leveled-latch circuit. Be careful because it is not triggered-latch circuit.

Note 1: The latches circuit holds data by pulling the LATCH terminal Low. And, when LATCH terminal is a High level, latch circuit doesn't hold data, and it passes from the input to the output. When ENABLE terminal is a Low level, output terminal OUTO to OUT15 respond to the data, and on and off does. And, when ENABLE terminal is a High level, it offs with the output terminal regardless of the data.

Truth Table

CLOCK	LATCH	ENABLE	SERIAL-IN	OUT0OUT7 OUT15	SERIAL-OUT
	Н	L	Dn	DnDn-7Dn-15	Dn-15
	L	L	Dn+1	No change	Dn-14
	Н	L	Dn+2	Dn+2Dn-5Dn-13	Dn-13
~ _	Х	L	Dn+3	Dn+2Dn-5Dn-13	Dn-13
—	Х	Н	Dn+3	OFF	Dn-13

Note 2: OUT0 to OUT15 = On when Dn = H; OUT0 to OUT15 = Off when Dn = L. In order to ensure that the level of the power supply voltage is correct, an external resistor must be connected between R-EXT and GND.

Warning: The following conditions, ENABLE=0, LATCH=1, SERIAL-IN=1, cannot be configured at the same time when power on, or IS31FL3726 will be abnormal.



ABSOLUTE MAXIMUM RATINGS

Supply voltage, V _{DD}	-0.3V ~ +6.0V
Voltage at any input pin	$-0.3V \sim V_{DD} + 0.2V$
Maximum junction temperature, T _{JMAX}	+150°C
Storage temperature range, T _{STG}	-65°C ~ +150°C
Operating temperature range, T _A =T _J	-40°C ~ +85°C
Junction Package thermal resistance, junction to ambient (4 layer	29.1°C/W (QFN)
standard test PCB based on JEDEC standard), θ_{JA}	77.9°C/W (eTSSOP)
ESD (HBM)	±3kV
ESD (CDM)	±1kV

Note 3: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITION

 $T_A = 25$ °C, unless otherwise specified.

Symbol	Characteristic	Condition	Min.	Тур.	Max.	Unit
V_{OUT}	Output voltage			0.7	4	V
f _{CLK}	Clock frequency (Note 4)	Cascade connected			20	MHz
t_{wLAT}	LATCH pulse width	Cascade connected	50			ns
t_{wCLK}	CLOCK pulse width		25			ns
4		Upper, I _{OUT} = 20mA	20			0
t _{wENA}	ENABLE pulse width (Note 4, 5)	Lower, I _{OUT} = 20mA	20			μs
t _{SETUP1}	Set-up time for CLOCK terminal		10			ns
t _{HOLD}	Hold time for CLOCK terminal		10			ns
t _{SETUP2}	Set-up time for LATCH terminal		50			ns

Note 4: Guaranteed by design.

Note 5: When the pulse of the Low level is input to the ENABLE terminal held in the High level.



ELECTRICAL CHARACTERISTICS

 $T_A = 25$ °C, $V_{DD} = 3.3V \sim 5.5V$, unless otherwise specified.

Symbol	Characteristic	Condition		Min.	Тур.	Max.	Unit
V_{DD}	Supply voltage	Normal operation		3.3		5.5	V
I _{OUT1}		$V_{OUT} = 0.4V$ $V_{DD} = 3.3V$	· R _{EXT} = 1kΩ	15	18.7	22	- mA
I _{OUT2}	Output current	$V_{OUT} = 0.4V$ $V_{DD} = 5.5V$	K _{EXT} - IKU	15	18.9	22	IIIA
Δl _{OUT1}	Output current error between bits	V _{OUT} ≥0.4V, All outputs on	R _{EXT} = 1kΩ		±3	±4	%
I _{oz}	Output leakage current input voltage	V _{OUT} = 5.0V				1	μA
V _{IH}	Input voltage			1.4			V
V_{IL}	iliput voltage					0.4	v
V_{OL}		$I_{OL} = 1.0 \text{mA}, V_{DD} =$	$1.0 \text{mA}, V_{DD} = 3.3 \text{V}$			0.3	
VOL	SOUT terminal voltage	I _{OL} = 1.0mA, V _{DD} = 5V				0.3	V
V_{OH}	3001 terminar voltage	$I_{OH} = -1.0 \text{mA}, V_{DD} = 3.3 \text{V}$		3			
V OH		I_{OH} = -1.0mA, V_{DD}	= 5V	4.7			
%/V _{DD}	Output current supply voltage regulation	When V_{DD} is ch 5.5V	When V _{DD} is changed 3.3V to 5.5V		-1		%
R _(UP)	Pull-up resistor	ENABLE termin	al	250	500	750	kΩ
R _(DOWN)	Pull-down resistor	LATCH terminal		250	500	750	K\$2
I _{DD(OFF)1}		V _{OUT} = 5V	R _{EXT} = OPEN		1		
I _{DD(OFF)2}	Supply current	V _{OUT} = 5V All outputs off	$R_{EXT} = 1k\Omega$		4.5		mA
I _{DD(ON)1}		V _{OUT} = 0.7V All outputs on	$R_{EXT} = 1k\Omega$		5		



SWITCHING CHARACTERISTICS

 $T_A = 25$ °C, unless otherwise specified.

Symbol	Characteristic	Condition	Min.	Тур.	Max.	Unit
t _{pLH1}		CLK-OUTn, LATCH = "H" ENABLE = "L"		80	200	
t _{pLH2}		LATCH-OUTn, ENABLE = "L"		80	200	
t_{pLH3}		ENABLE-OUTn, LATCH = "H"		2000		
t_{pLH}	Propagation delay	CLK-SERIAL OUT	3	5		200
t _{pHL1}	Propagation delay	CLK-OUTN, LATCH = "H" ENABLE = "L"		160	250	ns
t _{pHL2}		LATCH-OUTn, ENABLE = "L"		160	250	
t _{pHL3}		ENABLE-OUTn, LATCH = "H"		200	350	
t_{pLH}		CLK-SERIAL OUT	4	6		
t _{or}	Output rise time	10%~90% of voltage waveform	30	150	200	ns
t _{of}	Output fall time	90%~10% of voltage waveform	150	200	250	ns
t _r	Maximum CLOCK rise time	When not on DCD (Note)			5	μs
t _f	Maximum CLOCK fall time	When not on PCB (Note)			5	μs

Conditions: (Refer to test circuit.)

 $Topr = 25^{\circ}C, \ V_{DD} = V_{IH} = 3.3V \ and \ 5V, \ V_{OUT} = 0.7V, \ V_{IL} = 0V, \ R_{EXT} = 1000\Omega, \ V_{L} = 3.0V, \ R_{L} = 60\Omega, \ C_{L} = 10.5pF$

Note 6:

- 1. If the device is connected in a cascade and tr/tf for the waveform is large, it may not be possible to achieve the timing required for data transfer. Please consider the timings carefully.
- 2. Delay between outputs. The IS31FL3726 has graduated delay circuits between outputs. The fixed delay time is 5ns (typical), OUT1 has 5ns delay, OUT2 has 10 ns delay, etc. This delay prevents large inrush currents, which reduce power supply bypass capacitor requirements when the outputs turn on. The delay works during switch on and switch off of each output channel. LEDs that have not turned on before ENABLE is low will still turn on and off at the determined delayed time regardless of the state of ENABLE. Therefore, every LED will be illuminated for the amount of time ENABLE is pulled high.

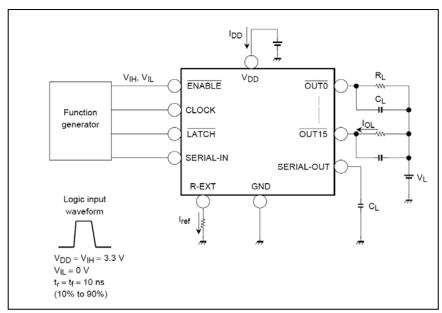
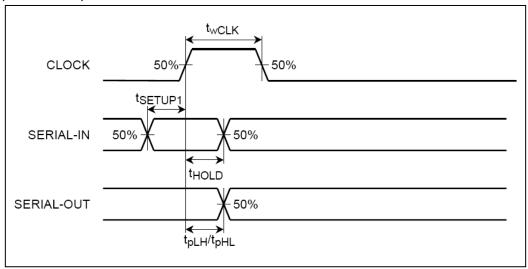


Figure 4 Test Diagram

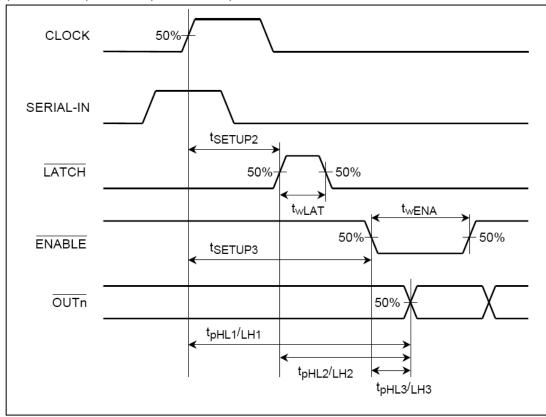


TIMING WAVEFORM

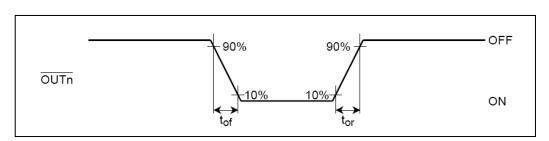
1. CLOCK, SERIAL-IN, SERIAL-OUT



2. CLOCK, SERIAL-IN, LATCH, ENABLE, OUTn



3. OUTn





TYPICAL OPERATING CHARACTERISTICS

ADJUSTING OUTPUT CURRENT

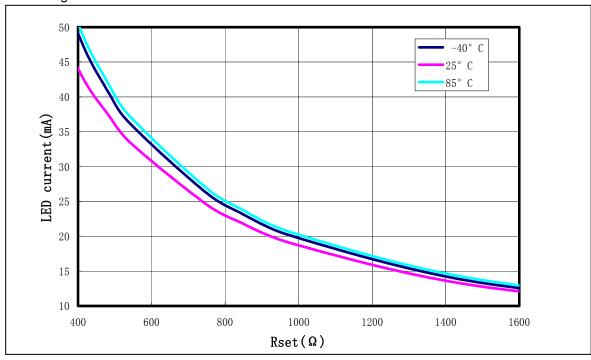
The output current of each channel is set by an external resistor R_{EXT} , the relationship between I_{OUT} and R_{EXT} is:

 $I_{OUT} = (V_{R-EXT}/R_{EXT}) \times 52$

the $V_{\text{R-EXT}}$ is 0.36V in the IS31FL3726,so we can count the I_{OUT} as :

 $I_{OUT} = 0.36 \times 52 / R_{EXT}$.

As show in the figure below:





CLASSIFICATION REFLOW PROFILES

Profile Feature	Pb-Free Assembly
Preheat & Soak Temperature min (Tsmin) Temperature max (Tsmax) Time (Tsmin to Tsmax) (ts)	150°C 200°C 60-120 seconds
Average ramp-up rate (Tsmax to Tp)	3°C/second max.
Liquidous temperature (TL) Time at liquidous (tL)	217°C 60-150 seconds
Peak package body temperature (Tp)*	Max 260°C
Time (tp)** within 5°C of the specified classification temperature (Tc)	Max 30 seconds
Average ramp-down rate (Tp to Tsmax)	6°C/second max.
Time 25°C to peak temperature	8 minutes max.

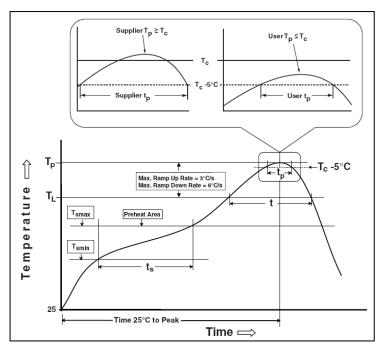
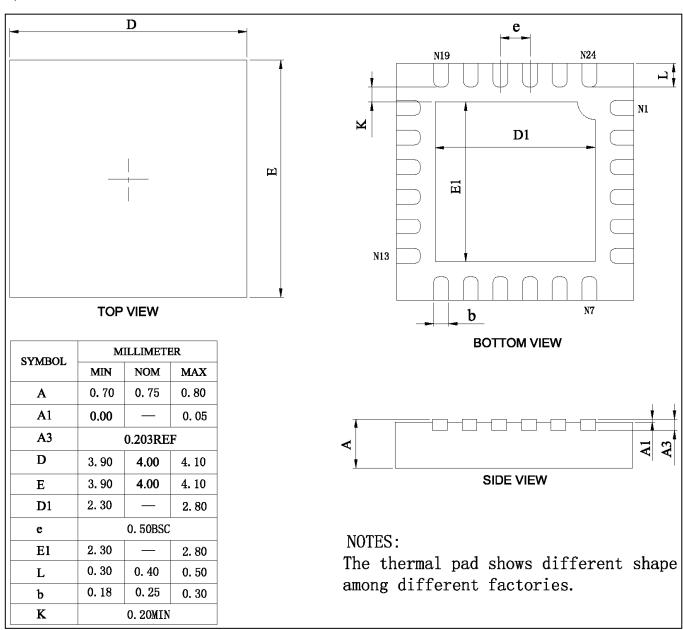


Figure 5 Classification Profile



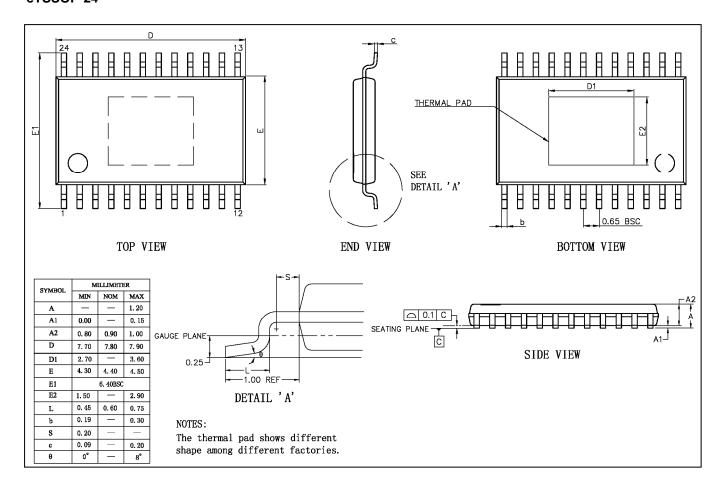
PACKAGE INFORMATION

QFN-24





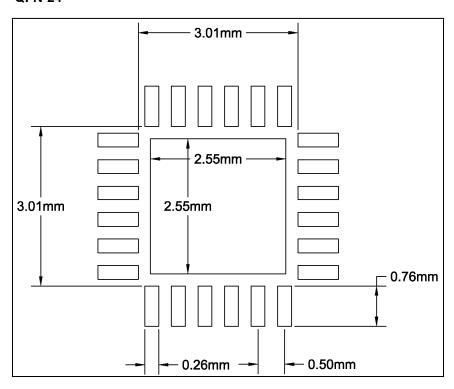
eTSSOP-24



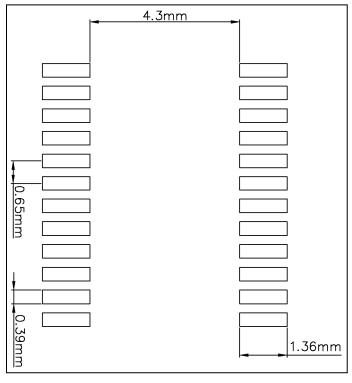


RECOMMENDED LAND PATTERN

QFN-24



eTSSOP-24



Note:

- 1. Land pattern complies to IPC-7351.
- 2. All dimensions in MM.
- 3. This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depends on many factors unknown (eg. user's board manufacturing specs), user must determine suitability for use.



REVISION HISTORY

Revision	Detail Information	Date
В	Initial release	2013.06.18
С	1. Update the Title 2. Add RECOMMENDED LAND PATTERN 3. Add REVISION HISTORY 4. Add RJA and ESD value 5. Add Figure 2 for Synchronization-Work	2018.05.30